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HEET

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100835639 Attorney Docket No.: 041501-5333 To the Assistant Commissioner for Patents: ATTN: BOX ASSIGNMENT Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): Name: LG Semicon Co., Ltd. Jin Soo KIM Additional name(s) of conveying party(ies) attached? Internal Address: _ Yes X No 3. Nature of conveyance: Street Address: 1, Hyangjeong-dong, Heungduk-ku, Cheongju-si, Chungcheongbuk-do, Korea X Assignment _ Merger __ Security Agreement _ Change of Name City: __ Other____ State: Zip: Additional name(s) & address(es) attached? August 1, 1998 Yes _X No Execution Date: 4. Application number(s) or patent number(s): 09150024 If this document is being filed together with a new application the execution date of the application is: August 1, 1998 B. Patent No.(s) A. Patent Application No.(s) Additional numbers attached: __ Yes X No 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: 1 concerning document should be mailed: 7. Total fee (37 C.F.R §3.41): __\$40.00 Mr. Robert J. Gaybrick Name: X Enclosed Authorized to be charged to deposit account 50-0310 Morgan, Lewis & Bockius LLP **Internal Address:** 1800 M Street, N.W. 8. Deposit account number: 50-0310 Street Address: Attach duplicate of page if paying by deposit account State: D.C. Zip: 20036 City: Washington 9. Statement and Signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. J. Michael Thesz September 9, 1998 Name of Person Signing Date 09/18/1998 JSHABAZZ 00000159 09150024 Total number of pages including cover sheet, attachments and documents: 2

ASSIGNMENT

WHEREAS I/We, the below named inventor(s entitled:), [hereinafter referred to as Assignor(s)], have made an invention
MASK ROM CELL AND METHOD OF FABR	RICATING THE SAME	
for which I/WE executed an application for United State concurrently herewith; or on, (Serial No,	tes Letters Patent	states Letters Patent on
WHEREAS. IG S	Semicon Co., Ltd.	
WHEREAS, LG S a corporation of Korea ungduk-ku, Cheong ju-si, Chungcheongbuk-do, F is desirous of securing the entire right, title, and interes	, whose post office (hereinal t in and to this invention, the application	address is I, Hyang jeong-dor fter referred to as Assignee), for United States Letters
Patent on this invention and the Letters Patent to be iss	sue upon this application;	
hereby acknowledged, I/WE, as assignor(s), have sold, and set over unto the assignee, its lawful successors and invention and this application, and all divisions, and commay be granted thereon, and all reissues thereof; and I Trademarks of the United States to issue all Letters Pa accordance with the terms of this Assignment;	l assigns, MY/OUR entire right, title, and tinuations thereof, and all Letters Patent WE hereby authorize and request the C	d interest in and to this t of the United States which commissioner of Patents and
AND, I/WE HEREBY further covenant and a assignee, its successors and assigns, any facts known to sign all lawful papers when called upon to do so, execut the title to this invention in said assignee, its successors applications, make all rightful oaths and generally do evand enforce proper patent protection for this invention the execution of such papers shall be borne by the assignment.	ME/US respecting this invention and test te and deliver all papers that may be need and assigns, execute all divisional, continuerly thing possible to aid assignee, its succession the United States, it being understood	stify in any legal proceeding, essary or desirable to perfect nuation, and reissue cessors and assigns, to obtain
AND, I/WE HEREBY authorize and request Attorney in this application, to insert here in parenthes the filing date and application number of said application	es (Application No, fi	
IN TESTIMONY WHEREOF, I/WE have he	reunto set our hand(s).	
Full Name of Sole of First Assignor Jin Soo KIM	Assignor's Signature (C:m J:1-5	Date Hng. 1. 1998
Address Doosan Hansol APT. 202-304, 4 Heungduk-ku, Cheongju-si, Chu	44-2, Kaeshin-dong,	Citizenship Republic of Korea
2. Full Name of Second Assignor	Assignor's Signature	Date
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MORGAN, LEWIS & BOCKIUS

PATENT REEL: 9456 FRAME: 0177

RECORDED: 09/09/1998